FAIRCHILD SEMICONDUCTOR™

April 1988
Revised August 1999

74F269
8-Bit Bidirectional Binary Counter

General Description

The 74F269 is a fully synchronous 8-stage up/down counter featuring a preset capability for programmable operation, carry lookahead for easy cascading and a U/$\overline{D}$ input to control the direction of counting. All state changes, whether in counting or parallel loading, are initiated by the rising edge of the clock.

Features

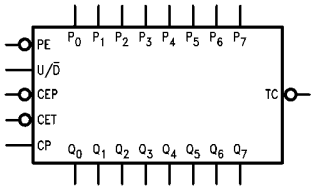
- Synchronous counting and loading
- Built-in lookahead carry capability
- Count frequency 100 MHz
- Supply current 113 mA typ
- 300 mil slimline package

Ordering Code:

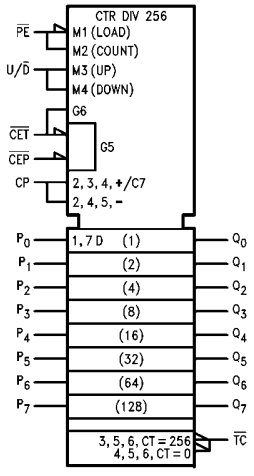
Order Number	Package Number	Package Description
74F269SC	M24B	24-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide
74F269SPC	N24C	24-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-100, 0.300 Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

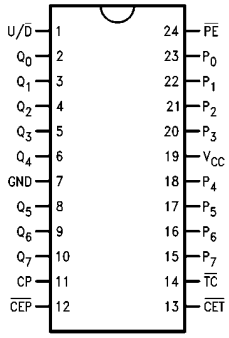
Logic Symbols



IEEE/IEC



Connection Diagram



Function Table

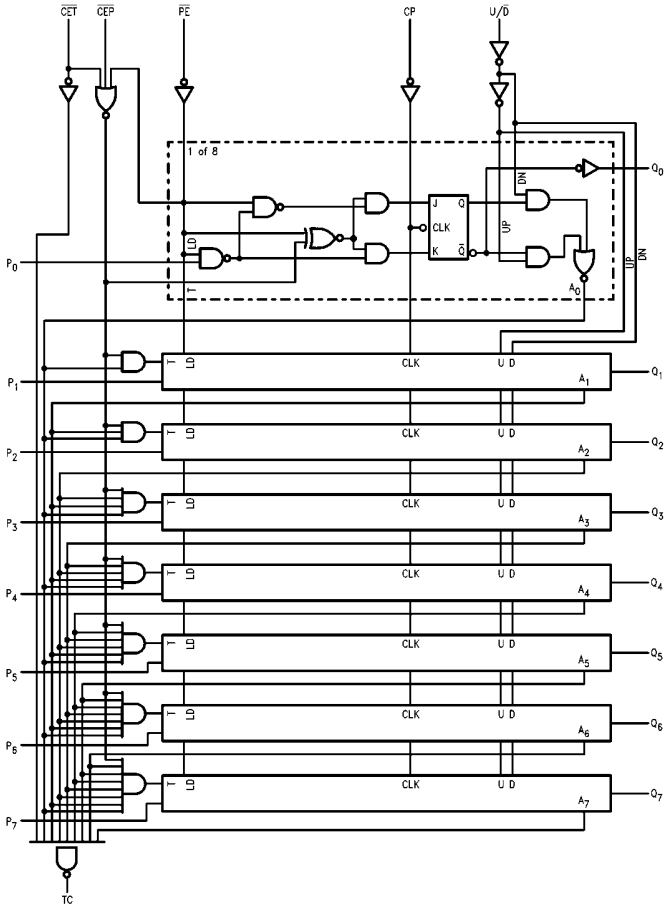
$\overline{PE}$	$\overline{CEP}$	$\overline{CET}$	U/$\overline{D}$	CP	Function
L	X	X	X	⌐	Parallel Load All Flip-Flops
H	H	X	X	⌐	Hold
H	X	H	X	⌐	Hold ($\overline{TC}$ Held HIGH)
H	L	L	H	⌐	Count Up
H	L	L	L	⌐	Count Down

H = HIGH Voltage Level
L = LOW Voltage Level
X = Immaterial
⌐ = Transition LOW-to-HIGH

Unit Loading/Fan Out

Pin Names	Description	U.L. HIGH/LOW	Input I_{IH}/I_{IL} Output I_{OH}/I_{OL}
P_0–P_7	Parallel Data Inputs	1.0/1.0	20 μA/–0.6 mA
$\overline{PE}$	Parallel Enable Input (Active LOW)	1.0/1.0	20 μA/–0.6 mA
U/$\overline{D}$	Up-Down Count Control Input	1.0/1.0	20 μA/–0.6 mA
$\overline{CEP}$	Count Enable Parallel Input (Active LOW)	1.0/1.0	20 μA/–0.6 mA
$\overline{CET}$	Count Enable Trickle Input (Active LOW)	1.0/1.0	20 μA/–0.6 mA
CP	Clock Input	1.0/1.0	20 μA/–0.6 mA
$\overline{TC}$	Terminal Count Output (Active LOW)	5.0/33.3	–1 mA/20 mA
Q_0–Q_7	Flip-Flop Outputs	50/33.3	–1 mA/20 mA

Logic Diagram



Absolute Maximum Ratings(Note 1)

Storage Temperature	−65°C to +150°C
Ambient Temperature under Bias	−55°C to +125°C
Junction Temperature under Bias	−55°C to +150°C
V_{CC} Pin Potential to Ground Pin	−0.5V to +7.0V
Input Voltage (Note 2)	−0.5V to +7.0V
Input Current (Note 2)	−30 mA to +5.0 mA
Voltage Applied to Output	
in HIGH State (with V_{CC} = 0V)	
Standard Output	−0.5V to V_{CC}
3-STATE Output	−0.5V to +5.5V
Current Applied to Output	
in LOW State (Max)	twice the rated I_{OL} (mA)

Recommended Operating Conditions

Free Air Ambient Temperature	0°C to +70°C
Supply Voltage	+4.5V to +5.5V

Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

DC Electrical Characteristics

Symbol	Parameter		Min	Typ	Max	Units	V_{CC}	Conditions
V_{IH}	Input HIGH Voltage		2.0			V		Recognized as a HIGH Signal
V_{IL}	Input LOW Voltage				0.8	V		Recognized as a LOW Signal
V_{CD}	Input Clamp Diode Voltage				−1.2	V	Min	I_{IN} = −18 mA
V_{OH}	Output HIGH Voltage	10% V_{CC}	2.5			V	Min	I_{OH} = −1 mA
		5% V_{CC}	2.7					I_{OH} = −1 mA
V_{OL}	Output LOW Voltage	10% V_{CC}			0.5	V	Min	I_{OL} = 20 mA
I_{IH}	Input HIGH Current				5.0	µA	Max	V_{IN} = 2.7V
I_{BVI}	Input HIGH Current Breakdown Test				7.0	µA	Max	V_{IN} = 7.0V
I_{CEX}	Output HIGH Leakage Current				50	µA	Max	V_{OUT} = V_{CC}
V_{ID}	Input Leakage Test		4.75			V	0.0	I_{ID} = 1.9 µA, All Other Pins Grounded
I_{OD}	Output Leakage Circuit Current				3.75	µA	0.0	V_{IOD} = 150 mV All Other Pins Grounded
I_{IL}	Input LOW Current				−0.6	mA	Max	V_{IN} = 0.5V
I_{OS}	Output Short-Circuit Current		−60		−150	mA	Max	V_{OUT} = 0V
I_{CCH}	Power Supply Current			104	125	mA	Max	V_O = HIGH
I_{CCL}	Power Supply Current			113	135	mA	Max	V_O = LOW

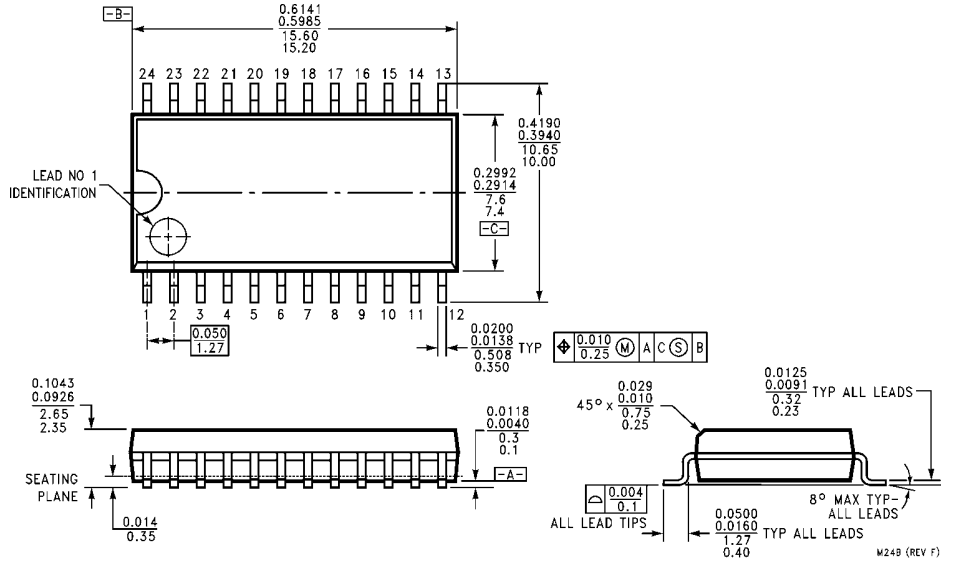
AC Electrical Characteristics

Symbol	Parameter	$T_A = +25°C$, $V_{CC} = +5.0V$, $C_L = 50$ pF			$T_A = 0°C$ to $+70°C$, $V_{CC} = 5.0V$, $C_L = 50$ pF		Units
		Min	Typ	Max	Min	Max	
f_{MAX}	Maximum Clock Frequency	100			85		MHz
t_{PLH}	Propagation Delay	3.5		8.0	3.5	7.0	ns
t_{PHL}	CP to Q_n (Count-Up)	4.5		10.5	4.5	11.0	
t_{PLH}	Propagation Delay	3.5		7.5	3.5	10.0	ns
t_{PHL}	U/$\overline{D}$ to $\overline{TC}$	4.5		7.5	4.5	11.0	
t_{PLH}	Propagation Delay	3.5		7.0	3.5	10.5	ns
t_{PHL}	$\overline{CET}$ to $\overline{TC}$	3.0		10.5	3.0	11.5	
t_{PLH}	Propagation Delay	4.5		10.0	4.5	10.5	ns
t_{PHL}	CP to $\overline{TC}$	5.0		10.0	4.5	10.5	
t_{PLH}	Propagation Delay	3.5		10.5	3.5	11.0	ns
t_{PHL}	CP to $_{Qn}$ (Count-Down)	4.5		10.5	4.5	11.0	
t_{PLH}	Propagation Delay	3.5		7.0	3.5	10.0	ns
t_{PHL}	CP to Q_n (Load)	4.0		7.0	4.0	7.0	

AC Operating Requirements

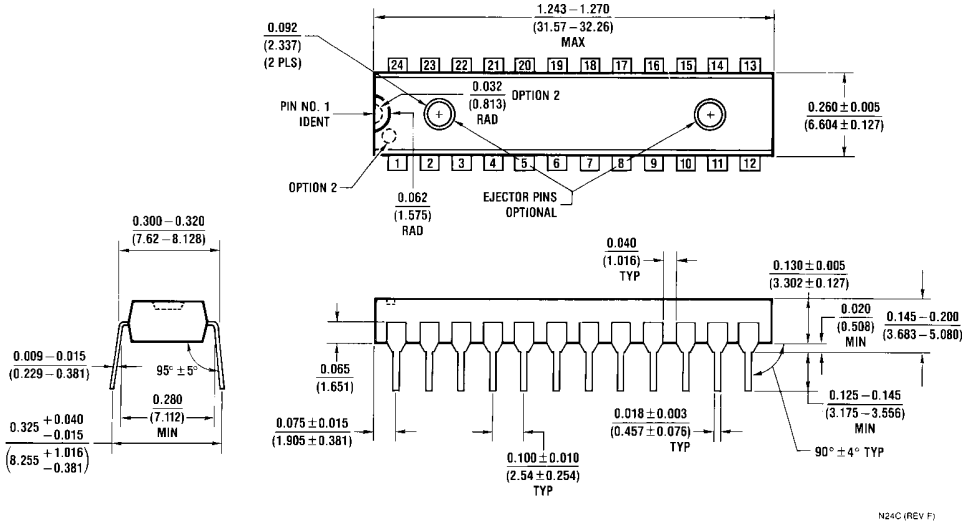
Symbol	Parameter	$T_A = +25°C$, $V_{CC} = +5.0V$		$T_A = 0°C$ to $+70°C$, $V_{CC} = 5.0V$		Units
		Min	Max	Min	Max	
$t_S(H)$	Setup Time, HIGH or LOW	3.5		4.0		ns
$t_S(L)$	Data to CP	3.0		3.0		
$t_H(H)$	Hold Time, HIGH or LOW	1.0		2.0		
$t_H(L)$	Data to CP	1.0		1.0		
$t_S(H)$	Setup Time, HIGH or LOW	5.5		6.5		ns
$t_S(L)$	$\overline{PE}$ to CP	5.5		6.5		
$t_H(H)$	Hold Time, HIGH or LOW	0		0		
$t_H(L)$	$\overline{PE}$ to CP	0		0		
$t_S(H)$	Setup Time, HIGH or LOW	6.0		6.5		ns
$t_S(L)$	$\overline{CET}$ or $\overline{CEP}$ to CP	8.0		9.0		
$t_H(H)$	Hold Time, HIGH or LOW	0		0		
$t_H(L)$	$\overline{CET}$ or $\overline{CEP}$ to CP	0		0		
$t_W(H)$	Clock Pulse Width, HIGH or LOW	3.5		3.5		ns
$t_W(L)$		3.5		4.0		
$t_S(H)$	Setup Time, HIGH or LOW	8.0		9.5		ns
$t_S(L)$	U/$\overline{D}$ to CP	6.0		7.0		
$t_H(H)$	Hold Time, HIGH or LOW	0.0		0.0		ns
$t_H(L)$	U/$\overline{D}$ to CP	0.0		0.0		

Physical Dimensions inches (millimeters) unless otherwise noted



28-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide
Package Number M24B

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



24-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-100, 0.300 Wide
Package Number N24C